## \* Program for March 20 (Thursday)

	Session A: Technical & Market Trends	Session B : Research & Development
10:00 - 11:45	A-1-1 "Controlled Polymer Dispersing Agent & Resin Free Pigment Concentration" Sun Gil Hong (Afcona Additives)	B-1-1 "Application of polymer hybrid materials to thermally conductive coatings"  Sang Eun Shim (Inha Univ.)
10:45 - 11:30	A-1-2 "High performance additives for pigment dispersion" Zhang, Zhihua (Solvay)	B-1-2 "Functional hybrid coatings based on organic-inorganic hybrid reactive precursors"  Juyoung Kim (Kangwon Nat'l Univ.)
11:30 - 12:15	A-1-3 "Utilization of additives for defects of coatings' surface" Lee, Seungwoo (BYK)	B-1-3 "The corrosion protection performance of epoxy coating modified by amino substituted polydimethylsiloxane"  Min Young Shon (Pukyung Nat'l Univ.)
12:15 - 13:30	Lunch Time	
13:30 - 14:15	A-2-1 "Recent trends of high performance films for display applications" Sangkug Lee (Korea Institute of Industrial Technology)	B-2-1 "Rheology and Curing Characteristics of Automotive Clearcoats" Hyun Wook Jung (Korea Univ.)
14:15 - 15:00	A-2-2 "Polyimide film as a key materials in IT industry" Chung-Seock Kang (Kolon Industries Inc.)	B-2-2 "Investigation of electrical and optical properties of ITO film on polymer substrates grown by roll to roll sputtering process" Sang Jin Lee (Korea Research Institute of Chemical Technology)
15:00 - 15:20	Coffee Break	
15:20 - 16:05	A-3-1 "Technology trends of polyester film for a wide variety of applications" Joonhee Han (SKC)	B-3-1 "Synthesis of photo-curable materials from biomass and their applications" Jin Ku Cho (Korea Institute of Industrial Technology)
16:05 - 16:50	A-3-2 "Touch panel industry and layer structure trend"  Duke Yi (IHS)	B-3-2 "Functional soft dispersed systems: Foam and Liquid marble" Prof. Syuji FUJII (Osaka Institute of Technology)
16:50 - 17:00	Coffee Break	
17:00 - 17:45	Special Invited Lecture: "Recent Advances in Superhydrophobic Nanomaterials and Nanoscale Systems" Professor Changsik Ha (Pusan Nat'l Univ.)	
17:45 - 18:00	SAIK General Meeting	
18:00 -	Banquet	

## \* Program for March 21 (Friday)

	Session A : Technical & Market Trends	Session B : Research & Development
10:00 - 10:45	A-4-1 "Synthesis, characterization, and application for new hydrocarbon resins"  Jun Hyo Park (Kolon Industries Inc.)	B-4-1 " UV-cured PSA for protective film"  Myung Cheon Lee (Dongguk Univ.)
10:45 - 11:30	A-4-2 "General Anti-corrosion Mechanism & Chromate Replacement" Bodan Ma (Halox)	B-4-2 "PSA design and application area"  Jong Bae Shim (Aekyung Chemical Co.)
11:30 - 12:15	A-4-3 "Innovative clear on Clear HMPSA to give the best Wet-out. Wash-off, Environment friendly HMPSA" Johan Dejonge (Bostik)	B-4-3 "Trend for semiconductor package tape and adhesive" Ik-Jun Choi (3M)
12:15 - 13:40	Lunch	Time
13:40 - 14:25	A-5-1 "Recent trends of polarizer film and adhesive tchnology" Won Kim (Cheil Industries Inc.)	B-5-1 "Design of High Strength and Impact Resistance Structural Adhesives" Youngson Choe (Pusan Nat'l Univ.)
14:25 - 15:10	A-5-2 "UV sealants for one drop fill (ODF) process of LCD" Katsunori Nishde (Sekisui Chemical Co.)	B-5-2 "Adhesion Technology and Application in Electronic Components" Dae-Jun Kim (SAMSUNG)
15:10 - 15:55	A-5-3 "High Performance 2 Component Waterborne Epoxy Systems" Jae Seong Kim (Huntsman)	B-5-3 "Sealing and bonding technologies for information display" Jun Hyup Lee (Myung Gi Univ.)